

GR-65J035KT: TO-247-4L Cascode GaN HEMT

Description

GR-65J035KT is a normally-off GaN High electron mobility transistor (HEMT) device using the cascode configuration, which provides high breakdown voltage, high current and high operating speed which is suitable for high power applications.

Key Specifications

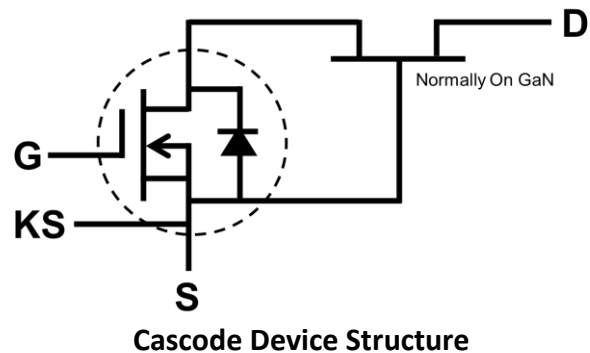
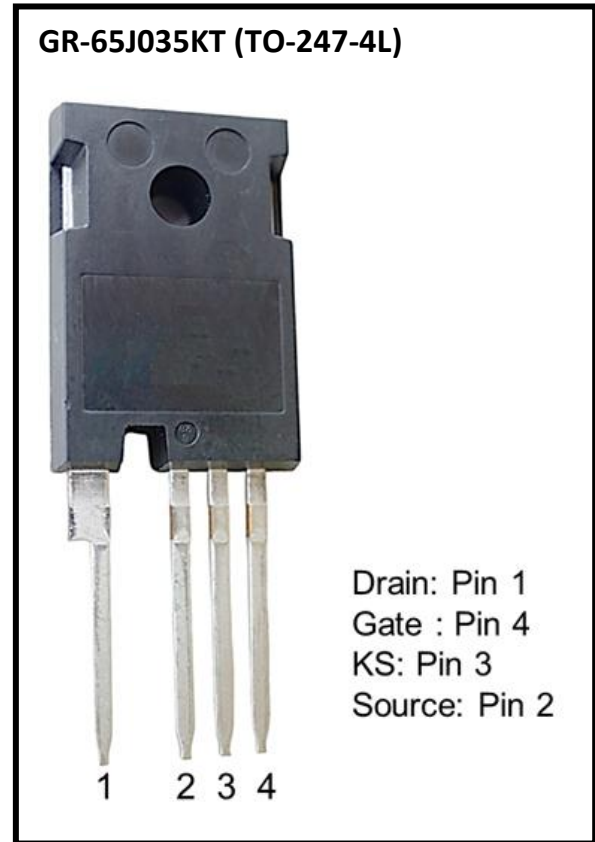
Part Number	GR-65J035KT
V_{DSS}	650V
$V_{(TR)DSS}$	800V
$R_{DS(ON)}$, typ.	34m Ω
Q_G , typ.	23.5nC
Package	TO-247-4L

Features

- Gate drive voltage compatibility (-20V to +20V)
- High operating frequency
- Pin to Pin with CoolMOS/SJ and SiC MOSFET
- Low Q_{rr}
- ESD-resistant
- Comply with JEDEC standards

Applications

- Switch Mode Power Supplies (SMPS)
- AC-DC/ DC-DC Converters
- Motor Drives



1- Electrical Characteristics

➤ **Table 1 Absolute maximum ratings**

Symbol	Parameter		Value	Unit
V_{DS}	Drain-source voltage		650	V
V_{GS}	Gate- source voltage		-20V ~ +20V	V
I_D	Drain current (continuous) at $T_C = 25^\circ\text{C}$ operation		52	A
	Drain current (continuous) at $T_C = 100^\circ\text{C}$ operation		33	A
$I_{D,pulse}$	Pulsed drain current (pulse width: 10 μs)		195	A
P_D	Maximum power dissipation $T_C=25^\circ\text{C}$		192	W
T_C	Operating temperature	Case	-55 to +150	$^\circ\text{C}$
T_J		Junction	-55 to +150	$^\circ\text{C}$
T_S	Storage temperature		-55 to +150	$^\circ\text{C}$
T_{SOLD}	Soldering peak temperature ^b		260	$^\circ\text{C}$
MSL	Moisture sensitivity level		MSL3	

a. In off-state, spike duty cycle $D < 0.01$, spike duration $< 1\mu\text{s}$

b. For 10 sec., 1.6mm from the case

➤ **Table 2 Thermal Characteristics**

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal resistance junction-ambient	55	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal resistance junction-case	0.65	$^\circ\text{C}/\text{W}$

➤ **Table 3 ESD Rating**

Symbol	Reference	Value	Unit
HBM (G-S) (G-D)	ANSI/ESDA/JEDEC JS-001-2024	2000	V
HBM (D-S)	ANSI/ESDA/JEDEC JS-001-2024	8000	V

➤ **Table 4 Electrical Characteristics** ($T_{CASE} = 25\text{ }^{\circ}\text{C}$ unless otherwise stated)

Symbol	Parameter	Conditions	Values			Unit
			min.	typ.	max.	
$V_{(BL)DSS}$	Drain-source voltage	$V_{GS}=0V$	650	-	-	V
$V_{GS(th)}$	Gate threshold voltage	$V_{GS}=V_{DS}$, $I_D=1mA$	2.0	3.0	4.0	V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS}=10V$, $I_D=20A$, $T_J=25^{\circ}\text{C}$	-	34	42	$m\Omega$
		$V_{GS}=10V$, $I_D=20A$, $T_J=150^{\circ}\text{C}$	-	64	-	
I_{DSS}	Drain-source leakage current	$V_{GS}=0V$, $V_{DS}=650V$, $T_J=25^{\circ}\text{C}$	-	3.5	70	μA
		$V_{GS}=0V$, $V_{DS}=650V$, $T_J=150^{\circ}\text{C}$	-	17.5	-	
I_{GSS}	Gate-to-source forward leakage current	$V_{GS}=20V$	-	-	400	nA
	Gate-to-source reverse leakage current	$V_{GS}=-20V$	-	-	-400	
C_{ISS}	Input capacitance	$V_{GS}=0V$, $V_{DS}=400V$, $f=1MHz$	-	1490	-	pF
C_{OSS}	Output capacitance		-	96	-	
C_{RSS}	Reverse transfer capacitance		-	4.7	-	
Q_G	Gate charge	$V_{GS}=0\sim 10V$, $V_{DS}=400V$, $I_{DS}=20A$	-	23.5	-	nC
Q_{GS}	Gate-source charge		-	5.8	-	
Q_{GD}	Gate-drain charge		-	5.3	-	
Q_{OSS}	Output charge	$V_{GS}=0V$, $V_{DS}=0\sim 400V$	-	147	-	
$t_{D(on)}$	Turn-on delay time	$V_{DS}=400V$, $V_{GS}=0$ to $10V$, $I_{DS}=20A$, $R_G=25\Omega$	-	24.5	-	ns
$t_{D(off)}$	Turn-off delay time		-	53	-	
Q_{RR}	Reverse recovery charge	$I_S=20A$, $V_{DS}=400V$	-	18	-	nC

2- Typical Characteristic Curves

Fig 1. On-Region Characteristics

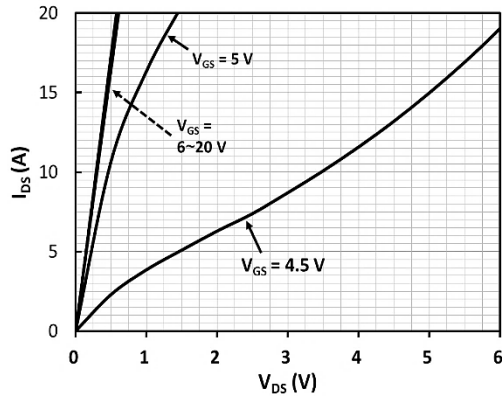


Fig 2. On-Resistance vs Drain Current and Temperature

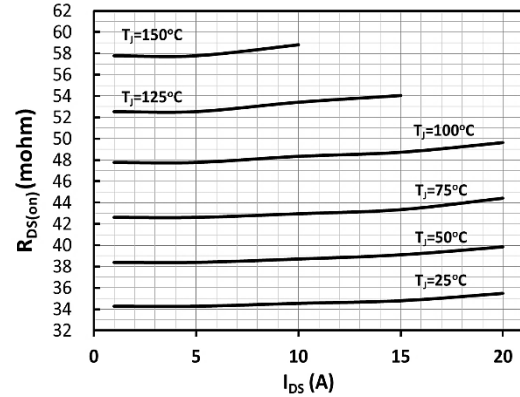


Fig 3. On-Resistance with Drain Current

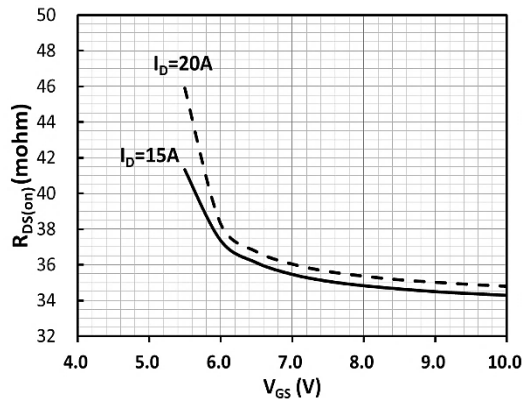


Fig 4. On-Resistance Variation with Temperature

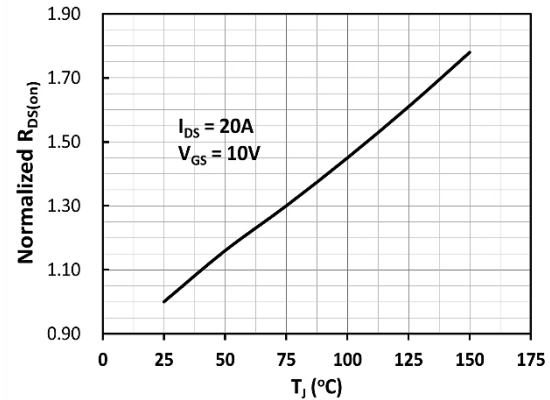


Fig 5. Threshold Voltage with Temperature

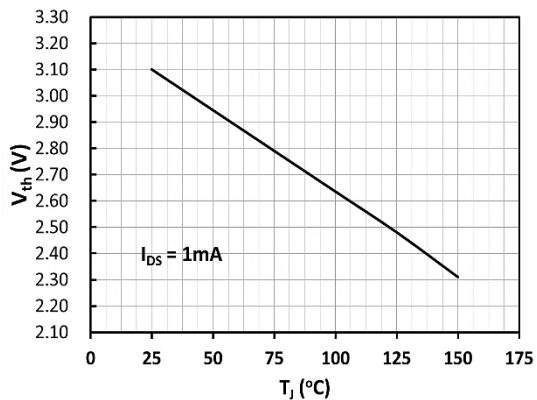


Fig 6. Capacitance Characteristics

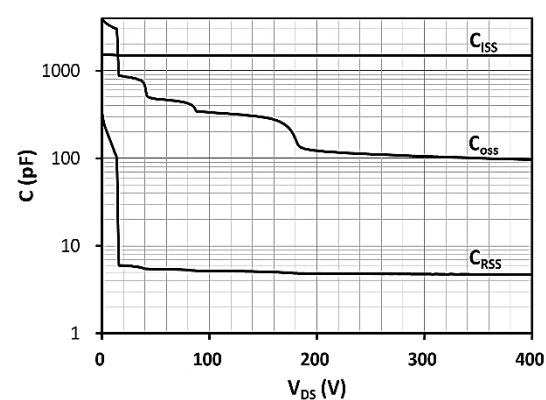


Fig 7. Gate Charge Characteristics, Q_g

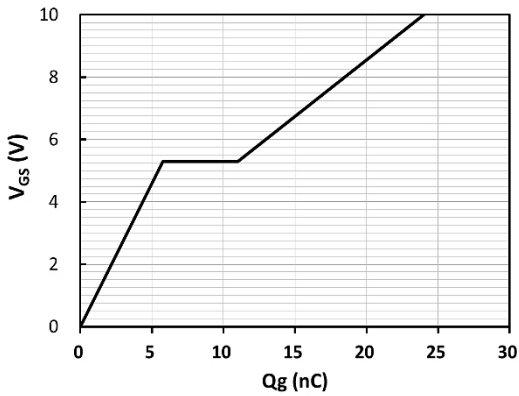


Fig 8. Capacitance Characteristics, Q_{oss}

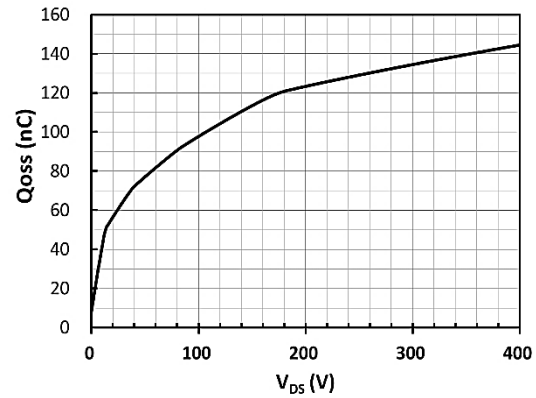
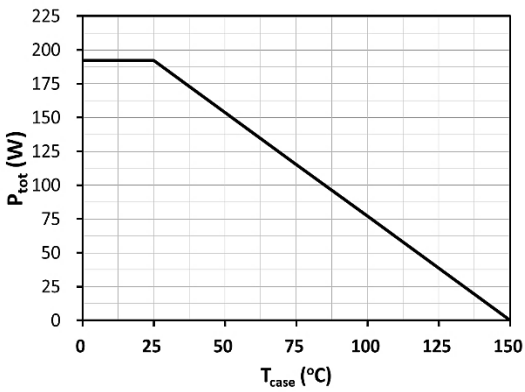
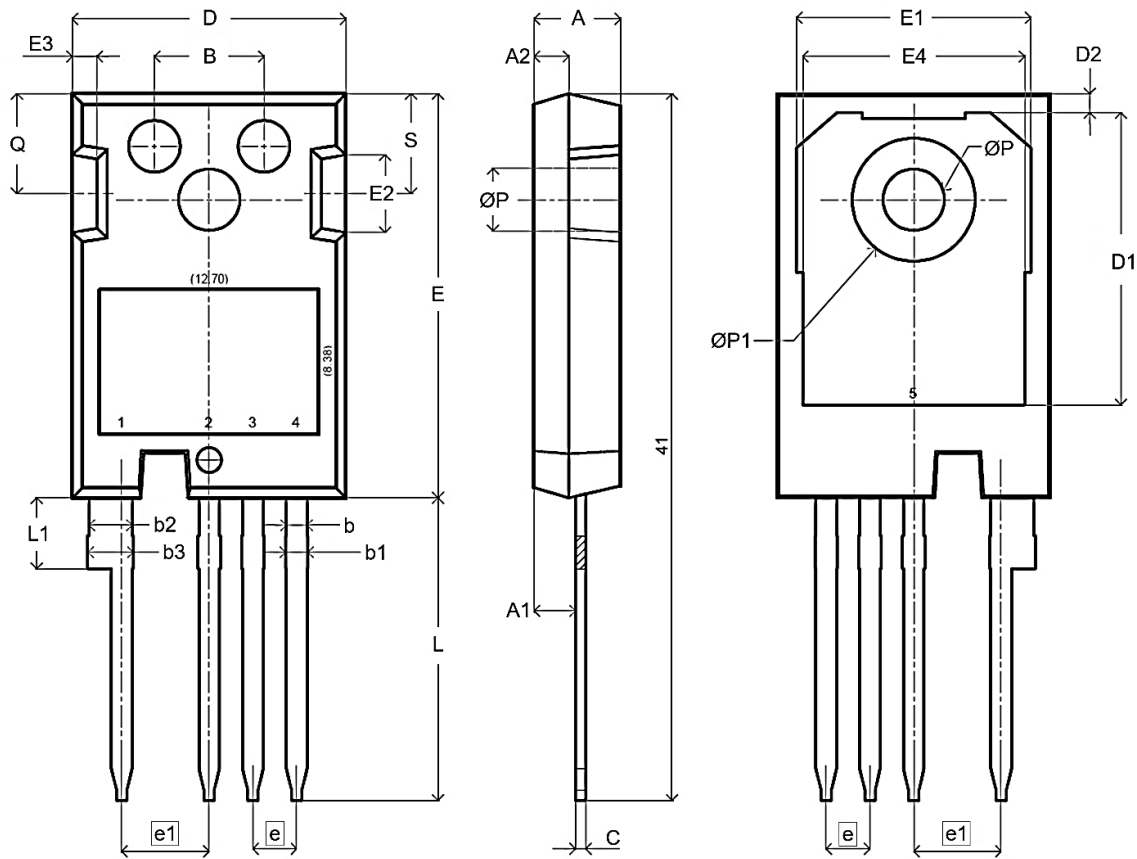


Fig 9. Source-drain diode forward characteristics



3- Package Outline Dimensions, GR-TO-247-4L

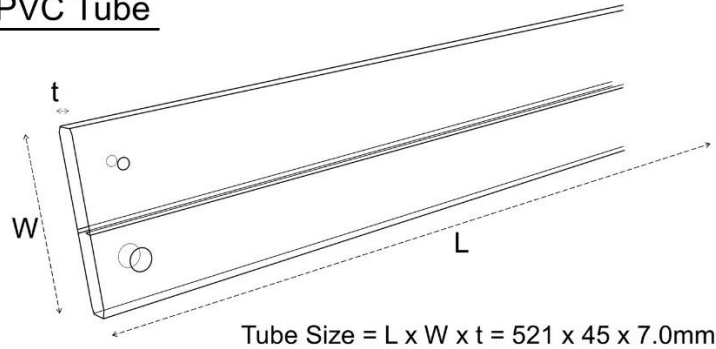


➤ Table 5 Dimension of GR-TO-247-4L

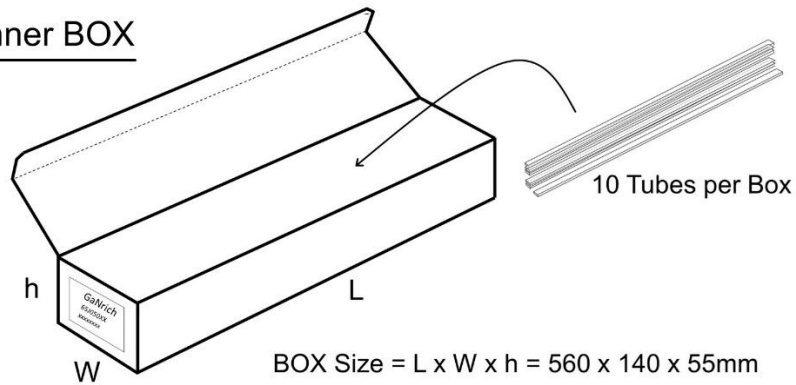
SYMBOL	DIMENSION (IN MM)			SYMBOL	DIMENSION (IN MM)		
	MIN.	NOM.	MAX.		MIN.	NOM.	MAX.
A	4.80	5.02	5.24	E	22.5	23.5	24.5
A1	2.20	2.40	2.60	E1	13.1	13.6	14.1
A2	1.90	2.00	2.10	E2	4.30	4.50	4.70
B	6.10	6.35	6.60	E3	1.20	1.45	1.70
b	1.00	1.20	1.40	E4	12.5	12.9	13.3
b1	1.10	1.30	1.50	e	2.54 BSC		
b2	2.40	2.50	2.60	e1	5.08 BSC		
b3	2.50	2.65	2.80	L	16.5	17.5	18.5
C	0.50	0.60	0.70	L1	4.00	4.10	4.20
D	15.70	15.90	16.10	ØP	3.40	3.60	3.80
D1	16.25	16.95	17.65	ØP1	7.00	7.20	7.40
D2	0.95	1.10	1.25	S	6.00	6.15	6.30
-	-	-	-	Q	5.50	5.75	6.00

4- Tube Package Information

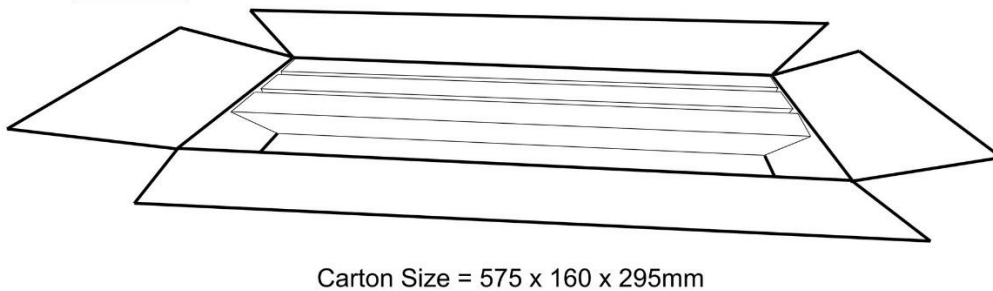
TO-247-3L, TO-247-4L
PVC Tube



Inner BOX



Carton



Package Type	Tube	Inner Box	Carton
TO-247-3L TO-247-4L	30 EA	300 EA	1500 EA
-	-	X10 Tube	X5 Box

5- Change Log

Version	Date	Description
01	Nov 28, 2023	Initial version
02	March 27, 2025	Electrical characteristics, Curve and Package information revised.
03	April 16, 2026	Electrical characteristics revised

- **Note:** GaNrich semiconductor reserves the right to revise products and/or specifications without notice.